

AEC Electronics Company Limited PRODUCT SPECIFICATION

# **CERAMIC RESONATOR**

# AEC PART NUMBER / SPEC. NO: ZTTCP6.00MG

#### **CUSTOMER:**



#### Peak soldering temperature 260°C/10 sec

**Ceramic component is exempted** (According to ROHS directive 2005/95/EC ANNEX point 7)

Customer's Name	
Production Name	Ceramic Resonator
Frequency	6.00MHz
Model No	ZTTCP6.00MG
Issue Date	23 <sup>rd</sup> April, 2020

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Prepared	Inspection	Approved
	Andy	Henkie

Product Specification	<b>Original Date</b>	23/04/2020
	PN:	ZTTCP6.00MG

# 1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with the type ZTTCP6.00MG

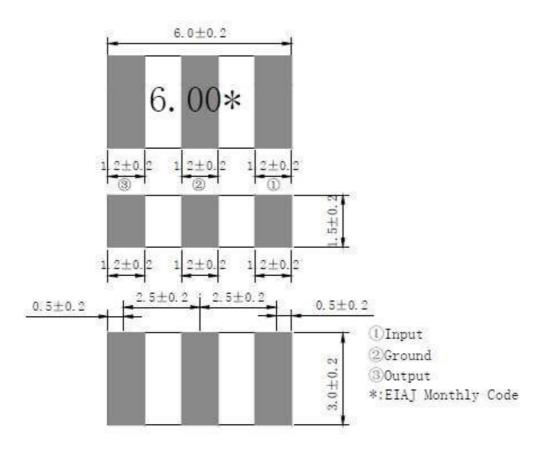
# 2. PART NO.:

PART NUMBER	CUSTOMER PART NO	SPECIFICATION NO
ZTTCP6.00MG		

# 3. OUTLINE DRAWING AND DIMENSIONS:

## **3.1** Appearance: No visible damage and dirt.

## 3.2 Dimensions:



Unit: mm

 Original Date
 23/04/2020

 PN:
 ZTTCP6.00MG

## 4. ELECTRICAL SPECIFICATIONS:

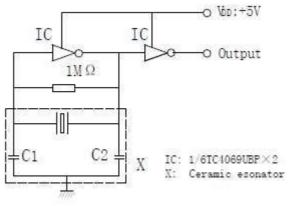
		Requirements	
4.1	Oscillation Frequency Fosc (MHz) )	6.00	
	Frequency Accuracy (%)	±0.5	
4.2	Resonant Impedance Ro (ΩΩmax	30	
4.3	Temperature Coefficient of Oscillation Frequency (%) max	±0±3 (Oscillation Frequency drift -20°C°©	
4.4	Withstanding Voltage	+80°C)℃ 100 VDC, 5 sec	
4.5	Rating Voltage $U_R$ (V)		
	(1) D.C. Voltage	6 VDC.	
	(2) A.C. Voltage	15 Vp-p.	
4.6	Insulation Resistance Ri, $(M\Omega\Omega)$ min	500 (10V, 1min)	
4.7	<b>Operating Temperature</b> (°C)°C	-20 ~ +80	
4.8	Storage Temperature (C)°C	-55 ~ +85	
4.9	Aging Rate (%) max	<u>±0±1</u> From initial value	

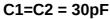
Components shall be left in a chamber of +85  $\pm 2^{\circ}$ C for 1000 hours, then measured after leaving

in natural condition for 1 hours.

# 5. MEASUREMENT:

- 5.1 Measurement Conditions: Parts shall be measured under a condition (Temp: : 20±15°C, Humidity : 65±20% R.H.) unless the standard condition (Temp.: 25±3 °C, Humidity : 65±5% R.H.) is regulated to measure.
- 5.2 Test Circuit:





# **6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS**

No	Item	Condition of Test		
				Requirements
6.1	Humidity	Keep the resonator at 40±2°C°	It shall fulfill the	
		90-95% RH for 96±4 hours. The	specifications in	
		the resonator into the room Co	ondition	Table 1.
		for 1 hour prior to the Measure	ement.	
6.2	Vibration	Subject the resonator to vibrat	tion for 2	It shall fulfill the
		hours each in $x_y$ and z axis	With the	specifications in
		amplitude of 1.5mm, the freque	ency shall	Table 1.
		be varied uniformly between tl	he limits of	
		10 Hz—55Hz.		
6.3	Mechanical	Drop the resonator randomly o	onto a	It shall fulfill the
	Shock	wooden floor from the height o	of 100cm 3	specifications in
		times.		Table 1.
6.4	Soldering	Passed through the re-flow ov	en under	It shall fulfill the
	Test	the following condition and lef	ft at room	specifications in
		temperature for 1 hour before		Table 1.
		measurement.		
		Temperature at the surface of	Time	
		the substrate		
		Preheat 150±5°C°C	60±10	
			sec	
		Peak 260±5℃°C	10±3 sec	
6.5	Solder	Dipped in 250±5℃€older bath	n for 3±0.5	The terminals shall
	Ability	sec seconds with rosin flux (2	5wt%	be at least 95%
		ethanol solution.)		covered by solder.
6.6	High	Subject the resonator to 80±5°	°C°for 96	It shall fulfill the
	Temperature	hours, then release the resona	ator into	specifications in
	Exposure	the room conditions for 1 hour	r prior to	Table 1.
		the measurement.		
6.7	Low	Subject the resonator to -20±5	°C°for 96	It shall fulfill the
	Temperature	hours, then release the resona	ator into	specifications in
	Exposure	the room conditions for 1 hour the measurement.	r prior to	Table 1.

Original Date PN: 23/04/2020

Product Specification

ZTTCP6.00MG

	Item	Condition of Test	
			Requirements
6.8	Temperature	Subject the resonator to -40°C°for 30	It shall fulfill the
	Cycling	min. followed by a high temperature of	specifications in
		85℃°@r 30 min.	Table 1.
		Cycling shall be repeated 5 times with a	
		transfer time of 15 sec. At the room	
		temperature for 1 hour prior to the	
		measurement.	
6.9	Board	Mount a glass-epoxy board	Mechanical
	Bending	(Width=40mm,thickness=1.6mm),then	damage such as
		bend it to 1mm displacement and keep it	breaks shall not
		for 5 seconds. (See the following figure)	occur.
		PRESS HEAD	
		RID	
		D.U.T.	
		10+	

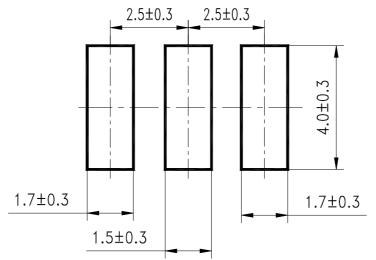
TABLE 1

ltem	Specification
Oscillation Frequency Change	±0.3
<u>∧</u> Æosc/Fosc (%) max Resonant Impedance Ro(ΩΩmax	35

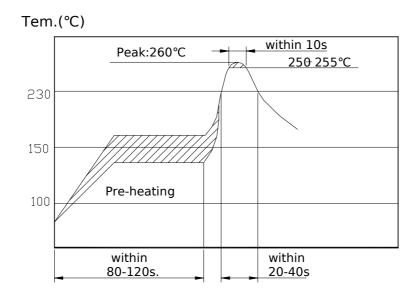
Note: The limits in the above table are referenced to the initial measurements.

Product Specification	Original Date	23/04/2020
r rouuct Specification	PN:	ZTTCP6.00MG

7.1Recommended land pattern



# 7.2 Recommended reflow soldering standard conditions



# 8 PACKAGE

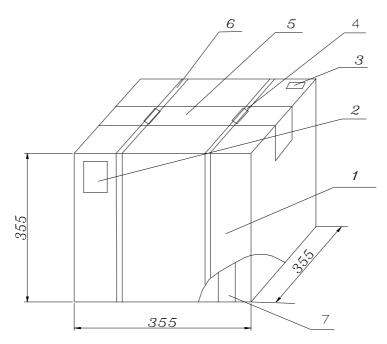
To protect the products in storage and transportation , it is necessary to pack them

(outer and inner package). On paper pack, the following requirements are requested.

### 8.1 Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it.

**Dimensions and Mark (see below)** 



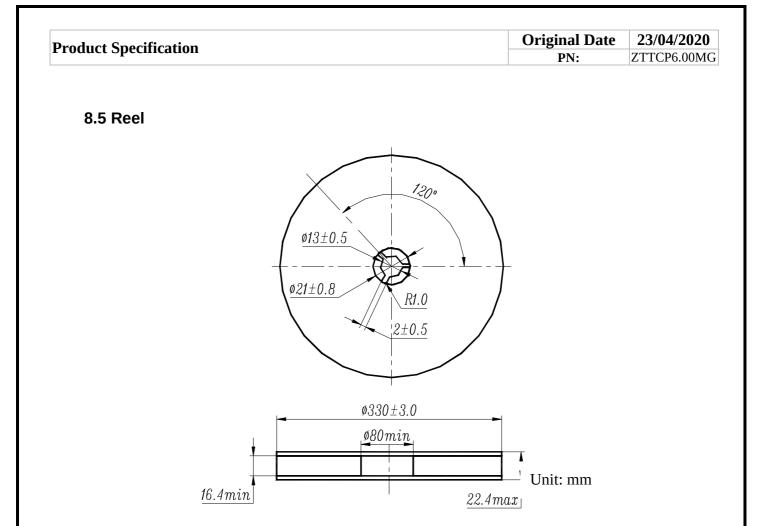
NO.	Name	Quantity	Notes
1	Package	1	
2	Certificate of approval	1	
3	Label	1	
4	Tying	2	
5	Adhesive tape	1.2m	
6	Belt	2.9m	
7	Inner Box	10	

#### 8.2 Section of package

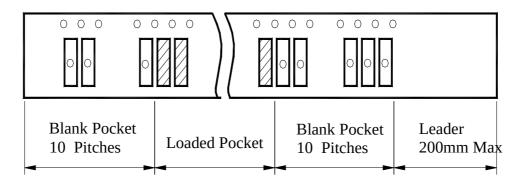
Package is made of corrugated paper with thickness of 0.8cm. Package has 10 inner boxes, each box has 1 reel (each reel for plastic bag).

roduct Specification			<b>Original Date</b>	23/04/2020
router opeenteuron			PN:	ZTTCP6.00M0
8.3 Quantity of pack	age			
Per plastic reel	4000	pieces of piezoelec	tric ceramic part	
Per inner box	1 ree	el		
Per package	10 ir	ner boxes(40000 pi	eces of piezoel	lectric
	ceramic	part))		
8.4 Inner Packing Di	mensions			
	340±2	34/92/2	9 1.UNIT: mm	
_	1 2	Label		
	۷	QC Label		

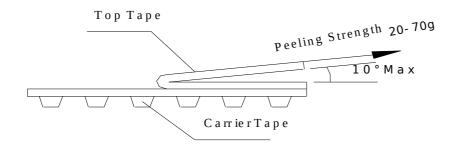
Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.



#### 8.6 Packing Method Sketch Map



# 8.7 Test Condition Of Peeling Strength



**Product Specification** 

 Original Date
 23/04/2020

 PN:
 ZTTCP6.00MG

## 9. EIAJ Monthly Code

2019/2021	2019/2021/2023/2025		/2022/2024
MONTH	CODE	MONTH	CODE
JAN	А	JAN	Ν
FEB	В	FEB	Р
MAR	С	MAR	Q
APR	D	APR	R
MAY	Е	MAY	S
JUN	F	JUN	Т
JUL	G	JUL	U
AUG	Н	AUG	V
SEP	J	SEP	W
OCT	K	OCT	Х
NOV	L	NOV	Y
DEC	М	DEC	Z

# 10 OTHER

10.1 Caution

10.1.1 Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.

10.1.2 Do not clean or wash the component for it is not hermetically sealed.

10.1.3 Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.

10.1.4 Don't be close to fire.

10.1.5 This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit

10.1.6 Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solderability or rusty. Please confirm solderability and characteristics for the products regularly.

10.2 Notice

10.2.1 Please return one of this specification after your signature of acceptance.

10.2.2 When something gets doubtful with this specifications, we shall jointly work to get an agreement.